GB100TS60NPbF

Vishay Semiconductors



PRODUCT SUMMARY

VCES

I_C DC

V_{CE(on)} at 100 A, 25 °C

INT-A-PAK "Half-Bridge" (Ultrafast Speed IGBT), 108 A



INT-A-PAK

600 V

108 A

2.6 V

FEATURES

Generation 5 Non Punch Through (NPT) technology



RoHS COMPLIANT

- Ultrafast: Optimized for hard switching speed 8 kHz to 60 kHz
- Low V_{CE(on)}
- 10 µs short circuit capability
- Square RBSOA
- Positive V_{CE(on)} temperature coefficient
- HEXFRED[®] antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al₂O₃ DBC
- UL approved file E78996 Nu
- Designed for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

BENEFITS

- · Benchmark efficiency for UPS and welding application
- Rugged transient performance
- Direct mounting on heatsink
- Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Collector to emitter voltage	V _{CES}		600	V		
Continuous collector current	1	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	108			
Continuous collector current	lc	$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	74			
Pulsed collector current	I _{CM}		200	А		
Clamped inductive load current	I _{LM}		200	A		
Diode continuous forward current	I _F	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	106			
		$T_{\rm C} = 80 \ ^{\circ}{\rm C}$	69			
Gate to emitter voltage	V _{GE}		± 20	V		
Maximum naviar dissinction	D	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$	390	W		
Maximum power dissipation	P _D	T _C = 80 °C	219	VV		
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V		

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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	DL TEST CONDITIONS		TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, \text{ I}_{C} = 500 \mu\text{A}$	600	-	-		
Collector to emitter voltage	V _{CE(on)}	$V_{GE} = 15 \text{ V}, I_{C} = 50 \text{ A}$	-	1.95	2.1		
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	2.6	2.85	v	
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 50 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$	-	2.21	2.44		
		V_{GE} = 15 V, I_{C} = 100 A, T_{J} = 125 °C	-	3.05	3.38		
Gate threshold voltage	$V_{GE(th)} \qquad V_{CE} = V_{GE}, I_C = 500 \ \mu A \qquad \qquad$		4.6	6			
Collector to emitter leakage current	I _{CES}	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.01	0.1	m ^	
		$V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 150 \ ^{\circ}C$	-	3.7	10	mA	
	V _{FM}	I _C = 50 A	-	1.35	1.66		
Diode forward voltage drop		I _C = 100 A	-	1.57	1.96	V	
		I _C = 50 A, T _J = 125 °C	-	1.27	1.50		
		I _C = 100 A, T _J = 125 °C	-	1.57	1.89		
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 200	nA	

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on switching loss	Eon		-	0.6	-	- mJ
Turn-off switching loss	E _{off}	I _C = 100 A, V _{CC} = 360 V, V _{GE} = 15 V, R _a = 4.7 Ω, L = 200 μH, T _J = 25 °C	-	1.1	-	
Total switching loss	E _{tot}	···g ···,oo p···, · Jo o	-	1.7	-	
Turn-on switching loss	Eon		-	0.8	-	
Turn-off switching loss	E _{off}		-	1.3	-	
Total switching loss	E _{tot}		-	2.1	-	
Turn-on delay time	t _{d(on)}	I_{C} = 100 A, V _{CC} = 360 V, V _{GE} = 15 V, R _g = 4.7 Ω, L = 200 µH, T _J = 125 °C	-	197	-	ns
Rise time	t _r	···g ···,oo p···, · J ·o o	-	50	-	
Turn-off delay time	t _{d(off)}		-	225	-	
Fall time	t _f		-	72	-	
Reverse bias safe operating area	RBSOA	$\begin{array}{l} {T_{J}} = 150 \ ^{\circ}\text{C}, \ \text{I}_{\text{C}} = 200 \ \text{A}, \\ {R_{g}} = 27 \ \Omega, \ \text{V}_{\text{GE}} = 15 \ \text{V} \ \text{to} \ 0 \end{array}$	Fullsquare			
Short circuit safe operating area	SCSOA	$ \begin{array}{l} T_J = 150 \ ^\circ C, \ V_{CC} = 400 \ V, \ V_P = 600 \ V, \\ R_g = 27 \ \Omega, \ V_{GE} = 15 \ V \ to \ 0 \end{array} $	10	-	-	
Diode reverse recovery time	t _{rr}		-	116	140	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _{CC} = 400 V, T _I = 25 °C	-	11	15	А
Diode recovery charge	Q _{rr}		-	600	1050	nC
Diode reverse recovery time	t _{rr}		-	152	190	ns
Diode peak reverse current	I _{rr}	I _F = 50 A, dI _F /dt = 200 A/μs, V _{CC} = 400 V, T _J = 125 °C	-	16	20	А
Diode recovery charge	Q _{rr}		-	1215	1900	nC

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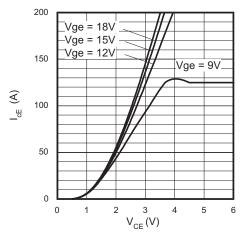
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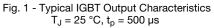
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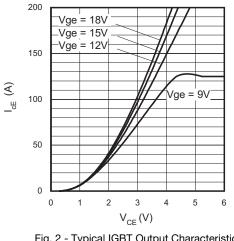


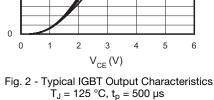
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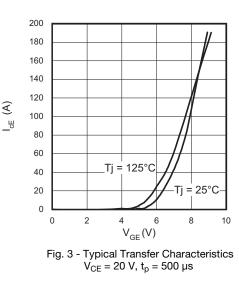
THERMAL AND MECHANICAL SPECIFICATIONS							
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS	
Operating junction and storage temperature range		T _J , T _{Stg}	- 40	-	150	°C	
Junction to case per leg	IGBT	D	-	0.23	0.32		
	Diode	R _{thJC}	-	0.38	0.64	°C/W	
Case to sink per module		R _{thCS}	-	0.1	-		
Mounting torque	case to heatsink		-	-	4	Nm	
Mounting torque	case to terminal 1, 2, 3		-	-	3		
Weight			-	185	-	g	

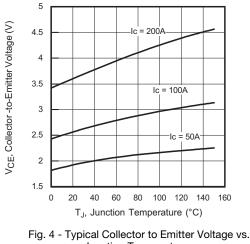












Junction Temperature, V_{GE} = 15 V, 500 µs pulse width

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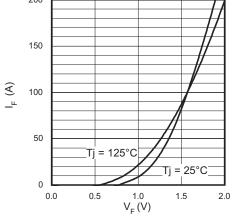


Fig. 5 - Diode Forward Characteristics, $t_p = 500 \ \mu s$

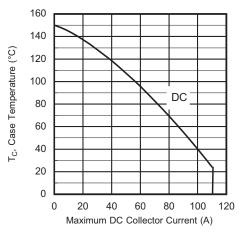


Fig. 6 - Maximum Collector Current vs. Case Temperature

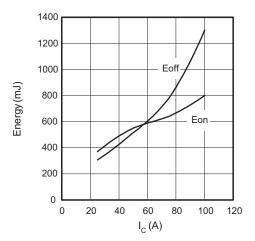
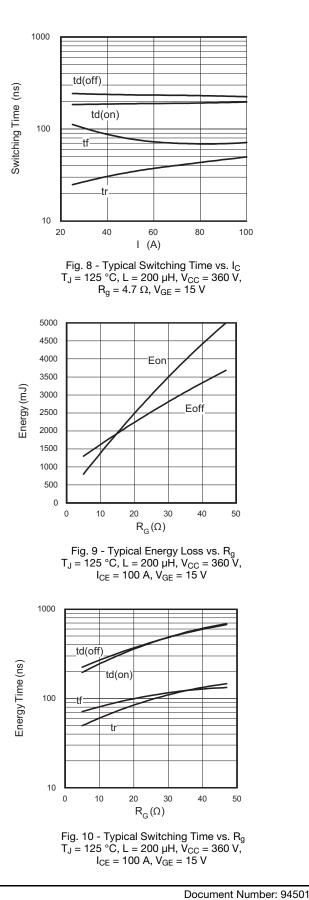


Fig. 7 - Typical Energy Loss vs. I_C, T_J = 125 °C, L = 200 $\mu H,$ V_{CC} = 360 V, R_g = 4.7 $\Omega,$ V_{GE} = 15 V

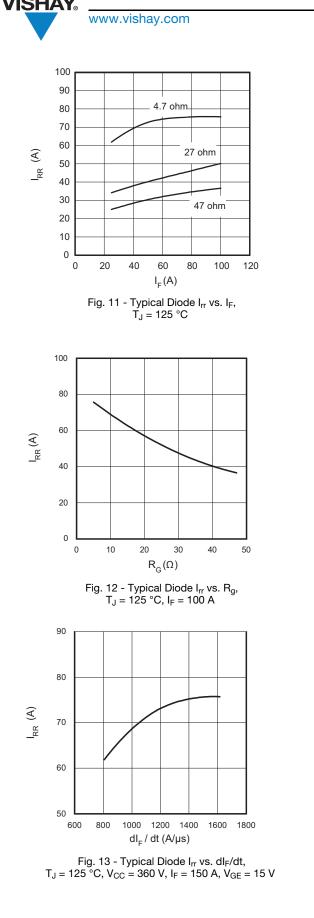


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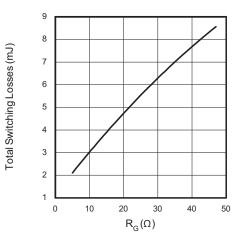
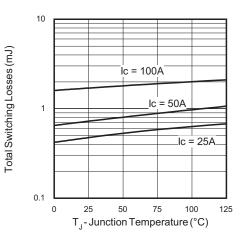
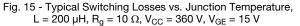


Fig. 14 - Typical Switching Losses vs. Gate Resistance, T_J = 125 °C, L = 200 $\mu H,~R_g$ = 10 $\Omega,$ V_{CC} = 360 V, V_{GE} = 15 V





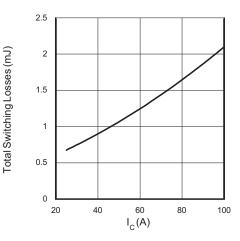


Fig. 16 - Typical Switching Losses vs. Collector to Emitter Current, T_J = 125 °C, R_{g1} = 4.7 V, R_{g2} = 0 Ω , V_{CC} = 360 V, V_{GE} = 15 V

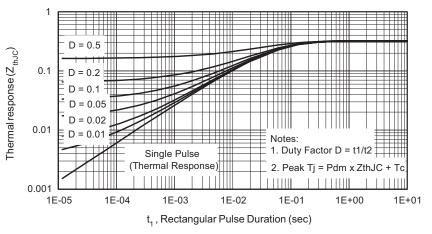
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Fig. 17 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

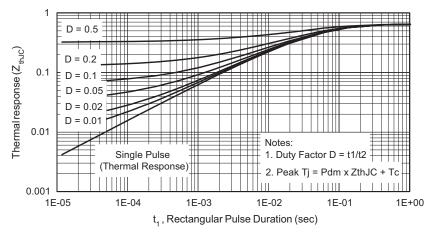


Fig. 18 - Maximum Transient Thermal Impedance, Junction to Case (HEXFRED®)

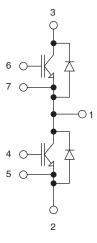
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ORDERING INFORMATION TABLE

Device code	G	В	100	т	S	60	N	PbF		
	1	2	3	4	5	6	7	8		
	1 -	Insulated Gate Bipolar Transistor (IGBT)								
	2 -	2 - B = IGBT Generation 5 NPT								
	3 -	- Current rating (100 = 100 A)								
	4 -	- Circuit configuration (T = Half-bridge)								
	5 -	Package indicator (S = INT-A-PAK)								
	6 -	Volt	Voltage rating (60 = 600 V)							
	7 -	Spe	Speed/type (N = Ultrafast IGBT)							
	8 -	Lea	Lead (Pb)-free							

CIRCUIT CONFIGURATION



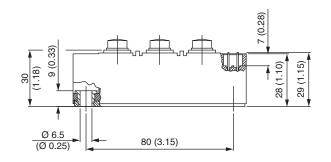
LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95543				

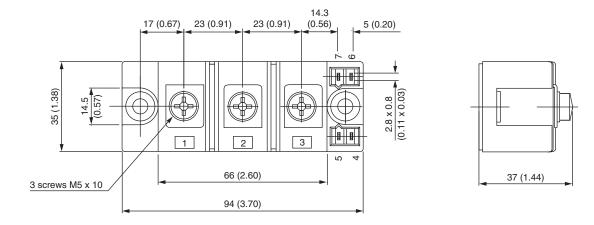




INT-A-PAK IGBT

DIMENSIONS in millimeters (inches)







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